TOSHIBA PHOTOCOUPLER

TLP721(D4)SERIES

ATTACHMENT: SPECIFICATIONS FOR VDE0884 OPTION: (D4)

Types: TLP721, TLP721F

Type designations for 'Option: (D4)', which are tested under VDE0884 requirements.

Ex. : TLP721 (D4-GR-LF4) D4 : VDE0884 option

GR: CTR rank LF4: lead bend

Note: Use Toshiba standard type number for safety standard application.

Ex. TLP721 (D4-GR-LF4) \rightarrow TLP721

VDE0884 ISOLATION CHARACTERISTICS

DESCRIPTION		SYMBOL	RATING	UNIT
Application Classification (DIN VDE0110 Teil 1/01.89, Table 1) for rated mains voltage≤300V _{rms} for rated mains voltage≤600V _{rms}			I-IV I-III	-
Climatic Classification (DIN IEC68 Teil 1/09.80)			40 / 100 / 21	_
Pollution Degree (DIN VDE0110 Teil 1/01.89)			2	_
Maximum Operating Insulation Voltage	TLP721	V _{IORM}	630	Vpk
	TLP721F		890	
Input to output Test Voltage, Method A Vpr=1.5×V _{IORM} , Type and Sample Test tp=60s, Partial Discharge<5pC	TLP721	Vpr	945	Vpk
	TLP721F		1335	
Input to output Test Voltage, Method B $ \begin{array}{c} \text{Vpr}\!=\!1.875\!\times\!\text{V}_{\mbox{IORM}},\ 100\%\ \mbox{Production Test} \\ t_p\!=\!1\text{s, Partial Discharge}\!<\!5\text{pC} \end{array} $	TLP721	- Vpr	1180	Vpk
	TLP721F		1670	
Highest Permissible Overvoltage (Transient Overvoltage, t _{pr} =10s)		$v_{ m TR}$	6000	Vpk
Safety Limiting Values (Max. permissible ratings in case of fault, also refer to thermal derating curve)				
Current (Input current IF, Psi = 0)	Isi	300	_{mA}	
Power (Output or Total Power Dissipation)	Psi	500	$_{ m mW}$	
Temperature	Tsi	150	°C	
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	Rsi	$\stackrel{\geqq}{=} 10^{12} \ \stackrel{\geqq}{=} 10^9$	Ω	

• This data sheet refers to TLP721 (D4, M), TLP721F (D4, M) that previously has a white-resin mold and have been changed. When designing new products please use black mold-resin devices.

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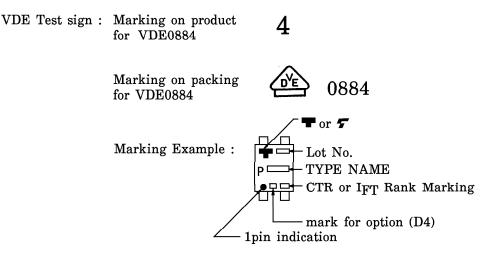
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INSULATION RELATED SPECIFICATIONS

		7.62mm pitch TLP721	10.16mm pitch TLP721F	
Minimum Creepage Distance (*)	Cr	7.0mm	8.0mm	
Minimum Clearance (*)	Cl	7.0mm	8.0mm	
Minimum Insulation Thickness	ti	0.5mm		
Comperative Tracking Index	CTI	175		
(DIN IEC112/VDE0303, Part 1)	CII	(VDE0110 Teil 1/01.89 Group Ⅲa)		

- ((*) in accordance with DIN VDE0110 Teil 1/01.89, Table 2, & 4)
 - (*1) If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value (e. g. at a standard distance between soldering eye centres of 7.5mm). If this is not permissible, the user shall take suitable measures.
 - This photocoupler is suitable for 'safe electrical isolation' only within the safety (*2)limit data.

Maintenance of the safety data shall be ensured by means of protective circuits.



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